

# CMS42N06V8-HF

**N-Channel  
RoHS Device  
Halogen Free**

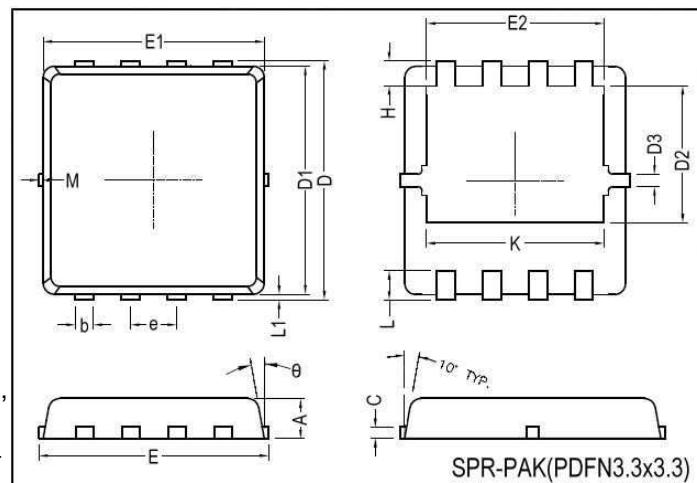
## Description

The CMS42N06V8 is using trench DMOS technology. This advanced technology has been especially tailored to minimize  $R_{DS(ON)}$ , provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

The CMS42N06V8 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

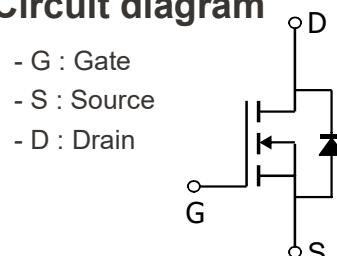
## Features

- Advanced DMOS Trench technology
- Improve dv/dt Capability
- Green Device Available
- Fast switching
- 100% EAS Guaranteed



REF.	Millimeter			REF.	Millimeter		
	Min.	Nom.	Max.		Min.	Nom.	Max.
A	0.70	0.75	0.80	E1	3.00	3.15	3.20
b	0.25	0.30	0.35	E2	2.39	2.49	2.59
C	0.10	0.15	0.25	e	0.65 BSC		
D	3.25	3.35	3.45	H	0.30	0.39	0.50
D1	3.00	3.10	3.20	L	0.30	0.40	0.50
D2	1.48	1.58	1.68	L1	-	0.13	0.20
D3	-	0.13	-	θ	-	10°	12°
E	3.20	3.30	3.40	M	-	-	0.15

## Circuit diagram



## Absolute Maximum Ratings

Parameter	Symbol	Ratings		Unit
Drain-Source Voltage	$V_{DS}$	60		V
Gate-Source Voltage	$V_{GS}$	$\pm 20$		V
Continuous Drain Current <sup>1</sup>	$I_D @ T_c=25^\circ\text{C}$	42		A
Continuous Drain Current <sup>1</sup>	$I_D @ T_c=100^\circ\text{C}$	26		A
Pulsed Drain Current <sup>1,2</sup>	$I_{DM}$	168		A
Total Power Dissipation <sup>4</sup>	$P_D @ T_c=25^\circ\text{C}$	52		W
	$P_D @ T_A=25^\circ\text{C}$	2		W
Single Pulse Avalanche Energy, $L=0.1\text{mH}^3$	$E_{AS}$	61		$\mu\text{J}$
Single Pulse Avalanche Current, $L=0.1\text{mH}^3$	$I_{AS}$	35		A
Operating Junction and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150		°C

## Thermal Data

Parameter	Symbol	Conditions	Max. Value	Unit
Thermal Resistance Junction-ambient <sup>1</sup>	$R_{\theta JA}$	Steady State	62.5	°C/W
Thermal Resistance Junction-case <sup>1</sup>	$R_{\theta JC}$	Steady State	2.4	°C/W

Electrical Characteristics ( $T_j = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	60	-	-	V	$\text{V}_{\text{GS}}=0, \text{I}_D=250\mu\text{A}$
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	1.2	1.6	2.2	V	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$
Gate-Source Leakage Current	$\text{I}_{\text{GSS}}$	-	-	$\pm 100$	nA	$\text{V}_{\text{GS}}= \pm 20\text{V}$
Drain-Source Leakage Current( $T_j=25^\circ\text{C}$ )	$\text{I}_{\text{DS}}$	-	-	1	$\mu\text{A}$	$\text{V}_{\text{DS}}=60\text{V}, \text{V}_{\text{GS}}=0$
Drain-Source Leakage Current( $T_j=125^\circ\text{C}$ )		-	-	10	$\mu\text{A}$	$\text{V}_{\text{DS}}=48\text{V}, \text{V}_{\text{GS}}=0$
Static Drain-Source On-Resistance <sup>2</sup>	$\text{R}_{\text{DS}(\text{ON})}$	-	10	12	$\text{m}\Omega$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=10\text{A}$
		-	12	15		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=8\text{A}$
Total Gate Charge <sup>2</sup>	$\text{Q}_g$	-	39.2	-	nC	$\text{I}_D=10\text{A}$ $\text{V}_{\text{DS}}=30\text{V}$ $\text{V}_{\text{GS}}=10\text{V}$
Gate-Source Charge	$\text{Q}_{\text{gs}}$	-	5.9	-		
Gate-Drain ("Miller") Change	$\text{Q}_{\text{gd}}$	-	8.8	-		
Turn-on Delay Time <sup>2</sup>	$\text{T}_{\text{d}(\text{on})}$	-	9.6	-	ns	$\text{V}_{\text{DD}}=15\text{V}$ $\text{I}_D=1\text{A}$ $\text{V}_{\text{GS}}=10\text{V}$ $\text{R}_G=6\Omega$
Rise Time	$\text{T}_r$	-	28.2	-		
Turn-off Delay Time	$\text{T}_{\text{d}(\text{off})}$	-	45.3	-		
Fall Time	$\text{T}_f$	-	10.9	-		
Input Capacitance	$\text{C}_{\text{iss}}$	-	2100	-	pF	$\text{V}_{\text{GS}}=0\text{V}$ $\text{V}_{\text{DS}}=25\text{V}$ $f=1.0\text{MHz}$
Output Capacitance	$\text{C}_{\text{oss}}$	-	165	-		
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$	-	80	-		
Gate Resistance	$\text{R}_g$	-	1.6	-	$\Omega$	$f=1.0\text{MHz}$

## Guaranteed Avalanche Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Single Pulse Avalanche Energy <sup>5</sup>	$\text{EAS}$	16.2	-	-	$\text{mJ}$	$\text{V}_{\text{DD}}=25\text{V}, \text{L}=0.1\text{mH}, \text{I}_{\text{AS}}=18\text{A}$

## Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Diode Forward Voltage <sup>2</sup>	$\text{V}_{\text{SD}}$	-	-	1.2	V	$\text{I}_S=10\text{A}, \text{V}_{\text{GS}}=0\text{V}, \text{T}_j=25^\circ\text{C}$
Continuous Source Current <sup>1,6</sup>	$\text{I}_S$	-	-	42	A	$\text{V}_G=\text{V}_D=0\text{V}$ , Force Current
Pulsed Source Current <sup>2,6</sup>	$\text{I}_{\text{SM}}$	-	-	84	A	

Notes: 1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2. The data tested by pulsed, pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
3. The EAS data shows Max. rating. The test condition is  $\text{VDD}=25\text{V}, \text{VGS}=10\text{V}, \text{L}=0.1\text{mH}, \text{IAS}=35\text{A}$ .
4. The power dissipation is limited by  $150^\circ\text{C}$  junction temperature.
5. The Min. value is 100% EAS tested guarantee.
6. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.

## TYPICAL CHARACTERISTIC

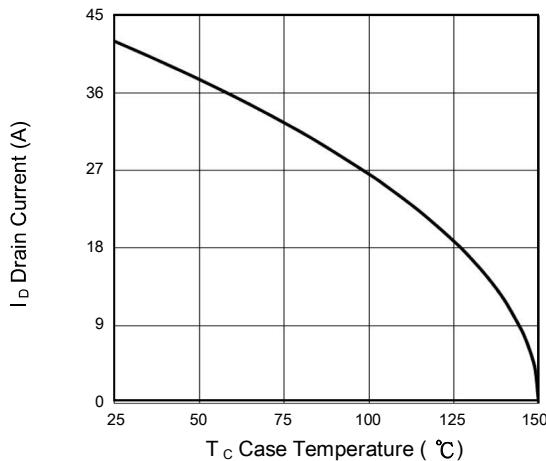
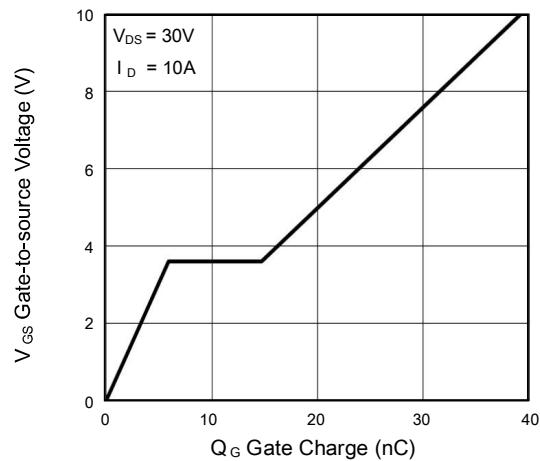
Fig.1 Drain Current vs.  $T_C$ 

Fig.2 Gate Charge Characteristics

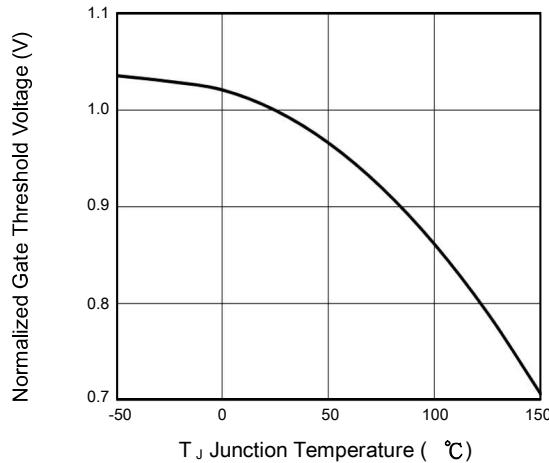
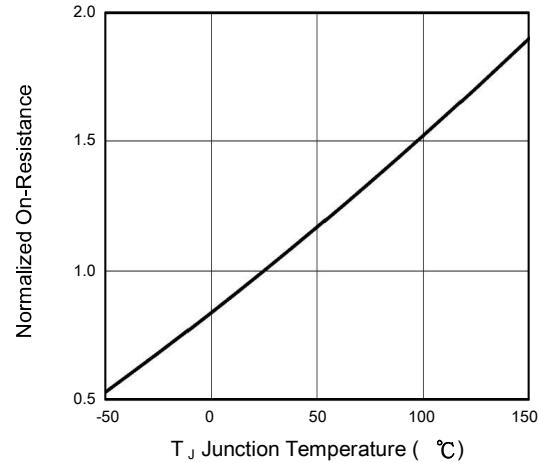
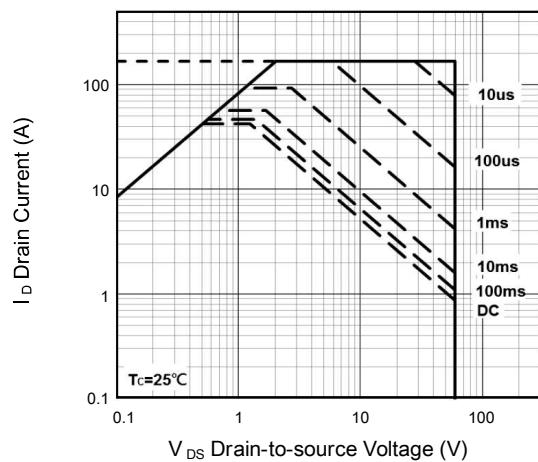
Fig.3 Normalized  $V_{GS(th)}$  vs.  $T_J$ Fig.4 Normalized  $R_{DS(on)}$  vs.  $T_J$ 

Fig.5 Safe Operating Area

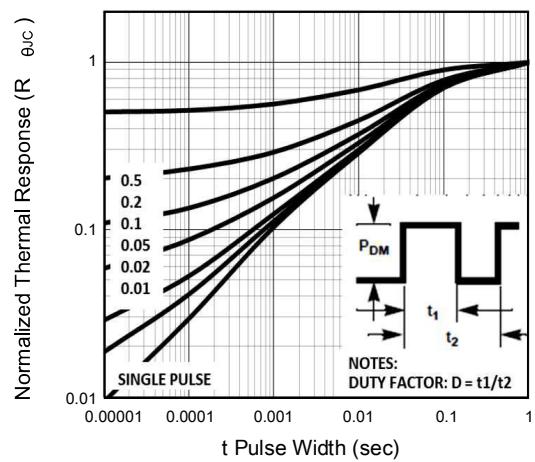


Fig.6 Transient Thermal Impedance

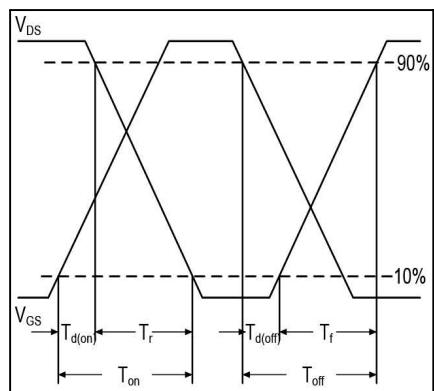


Fig.7 Switching Time Waveform

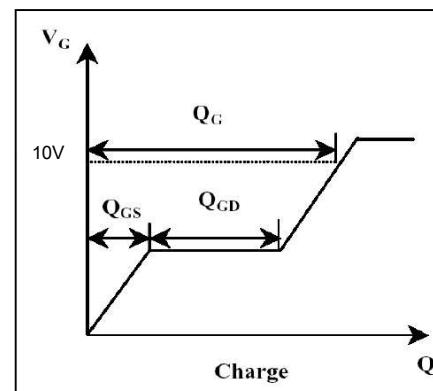
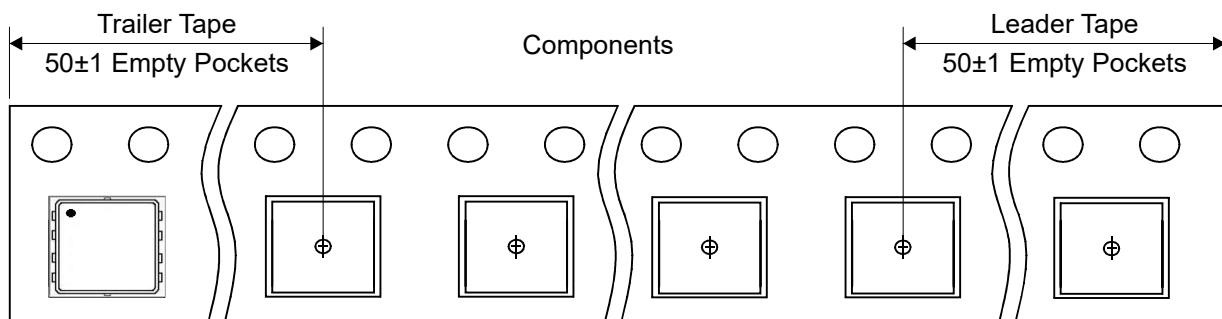
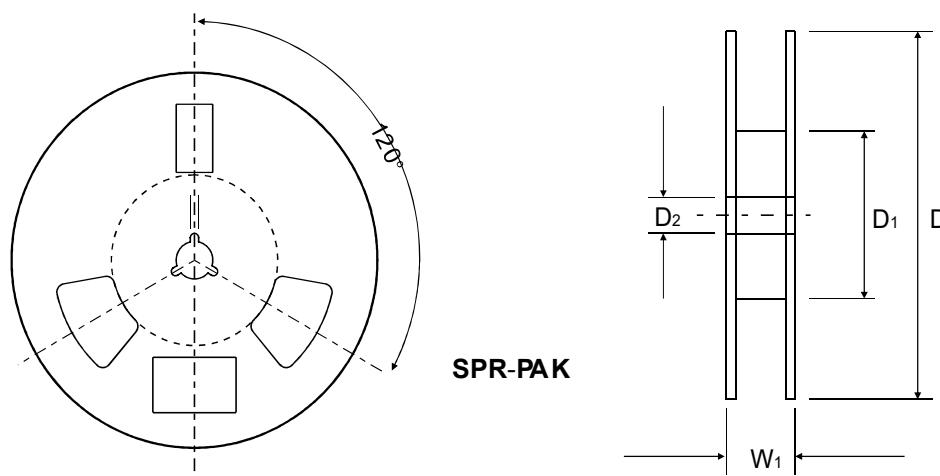
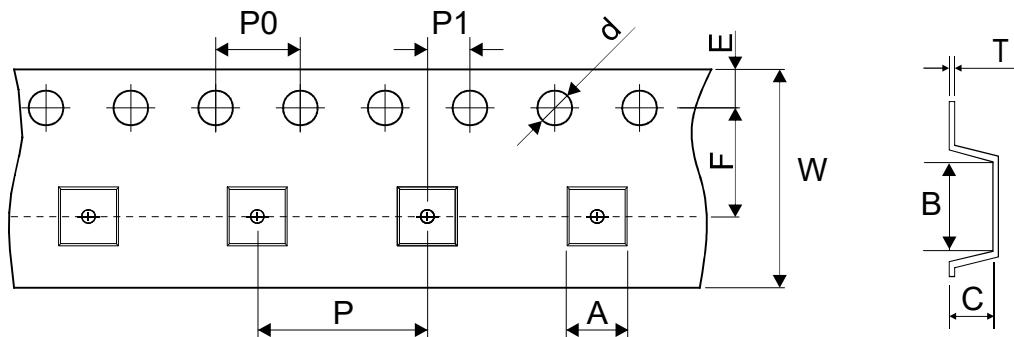


Fig.8 Gate Charge Waveform

## Reel Taping Specification



	SYMBOL	A	B	C	d	D	D1	D2
SPR-PAK	(mm)	$3.55 \pm 0.10$	$3.55 \pm 0.10$	$1.40 \pm 0.10$	$1.50 \pm 0.10$	$330 \pm 1.00$	$178 \pm 1.00$	$20.20 \pm 1.00$
	(inch)	$0.139 \pm 0.004$	$0.139 \pm 0.004$	$0.055 \pm 0.004$	$0.059 \pm 0.004$	$13.00 \pm 0.039$	$7.00 \pm 0.039$	$0.795 \pm 0.039$

	SYMBOL	E	F	P	P0	P1	W	W1
SPR-PAK	(mm)	$1.75 \pm 0.10$	$5.50 \pm 0.10$	$8.00 \pm 0.10$	$4.00 \pm 0.10$	$2.00 \pm 0.10$	$12.00 \pm 1.00 / -0.10$	$18.40 \pm 1.00$
	(inch)	$0.069 \pm 0.004$	$0.217 \pm 0.004$	$0.315 \pm 0.004$	$0.157 \pm 0.004$	$0.079 \pm 0.004$	$0.472 \pm 0.039 / -0.004$	$0.724 \pm 0.039$

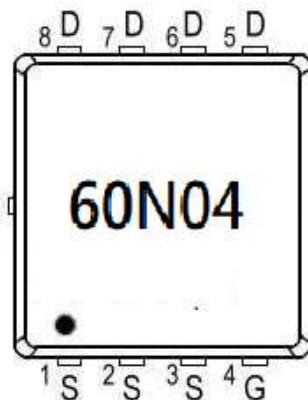
Company reserves the right to improve product design , functions and reliability without notice.

REV:A

# CMS42N06V8-HF

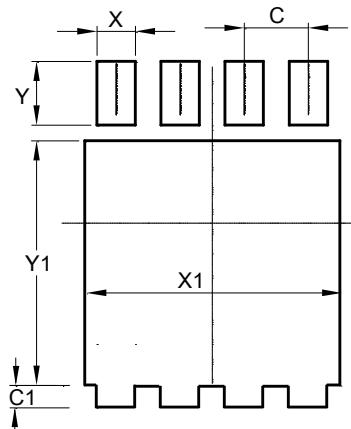
## Marking Code

Part Number	Marking Code
CMS42N06V8-HF	60N04



## Suggested PAD Layout

Dimensions	Value (in mm)
C	0.65
C1	0.40
X	0.40
X1	2.80
Y	0.60
Y1	2.35



Note:

1. The pad layout is for reference purposes only.

## Standard Packaging

Case Type	REEL PACK	
	REEL ( pcs )	Reel Size (inch)
PDFN	3,000	13